## EAST Search History

Ref	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L21	5	(*3608186*),PN.	US-PGPUB; USPAT;	OR	OFF	2006/03/02 20:27
			USOCR; EPO; JPO; DERWENT;			
S1	2	(*6323542*).PN.	IBM_TDB US-PGPUB:	OR	ON	2006/02/28 21:38
31	-	( 023042 ).FN.	USPAT; EPO; JPO;	UA		200002/28 21.38
			DERWENT; IBM_TDB			.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,
S3	2	("20020030258").PN:	US-PGPUB; USPAT;	OR	OFF	2006/03/01 13:48
			EPO; JPO; DERWENT; IBM_TDB			
S4	50	("4530152" "4741787" "5128746" "5139969" "5157480" "5258577" "5266528" "5302849" "5307561" "53 09021" "5363277" "5408320" "5431328" "5444301" "5496775" "5554887" "5656863" "5668404" "57669	US-PGPUB; USPAT;	OR	ON	2006/02/28 21:59
		72" "5824569" "5930603" "5969426" "6069408" "6294830" "6307261").PN	EPO; JPO; DERWENT;			
S5	13	(("0864725") or ("0745649") or ("5824569") or ("5641997") or ("5334875") or ("5288943")).PN.	IBM_TDB US-PGPUB;	OR	OFF	2006/02/28 22:01
			USPAT; EPO; JPO; DERWENT;			
S6	7	*0864725* *0745649*	IBM_TDB US-PGPUB;	OR	ON	2006/02/28 22:01
			USPAT; EPO; JPO;			
			DERWENT; IBM_TDB	<u> u</u>	::: <u>:</u> ::::::::	
\$7	<i>,</i>	*0864725* *0745649*	US-PGPUB; USPAT; EPO; JPO;	OR	ON	2006/02/28 22:01
			DERWENT; IBM_TDB			
S8	0	"8064725" "7045649"	US-PGPUB; USPAT;	OR	ON	2006/02/28 22:02
			EPO; JPO; DERWENT; IBM_TDB			
S9	9	*08064725* *07045649*	US-PGPUB; USPAT;	OR	ON	2006/02/28 22:04
			EPO; JPO; DERWENT; IBM_TDB			
S10	170	US-N001144*, DID. OR US-0990F01*, DID. OR US-09766656*, DID. OR US-N09802338*, DID. OR US-1020036*, DID. OR US-3608166*, DID. OR US-3693244*, DID. OR US-3959874*, DID. OR US-3959874*, DID. OR US-3608166*, DID. OR US-4970689*, DID. OR US-540820*, DID. OR US-560820*, DID. OR US	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/28 22:10
S11	2774031	US-N09802338-\$.DID. OR US-06342794-\$.DID. @ad> "20030319" @rlad> "20030319" @pt1d> "20030319"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/28 22:11

## EAST Search History

S12	170	S10 not S11	US-PGPUB:	OR	ON	2006/03/01 12:17
312	,,,	SIONOLS IT	USPAT; EPO; JPO; DERWENT; IBM_TDB		0.4	2000/03/07 12:17
S17	152	257/171.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT;	OR	ON	2005/03/01 13:40
S18	443	257/374.ccls.	US-PGPUB; US-PGPUB; USPAT; EPO; JPO; DERWENT;	OR	ON	2006/03/01 13:41
S19	215	257/397.ccls.	IBM_TDB US-PGPUB; USPAT; EPO; JPO;	OR	ON	2006/03/01 13:41
S20	619	257/466.ccls.	DERWENT; IBM_TDB US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 13:42
S21	886	257/510.cc/s.	US-PGPUB; USPAT; EPO; JPO; DERWENT;	OR	ON	2005/03/01 13:43
S22	81	257/e23.131.cds.	IBM_TDB US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 13:43
S24	233	257/921.238.cc/s.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 13:43
S25	289	257/e21.553.cds.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 13:44
S26	180	257/e21.555.cds.	US-PGPUB; USPAT; EPO; JPO; DERWENT;	OR	ON	2005/03/01 14:01
S27	2	("20040238926").PN.	IBM_TDB US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/01 20:10
S28	2774031	@acb="20030319" @rlad>"20030319" @pt1d>"20030319"	US-PGPUB; USPAT; EPO; JPO; DERWENT;	OR	ON	2006/03/01 14:01
S29	180	257/e21.555.cc/s. not S28	IBM_TDB US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 14:04
S30	2745	(S17 S18 S19 S20 S21 S22 S24 S25) not (S26 S29)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 14:04
S31	1119	wafer and S30	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 14:22
S32	191	438/114.ccls. not \$28	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 15:52
S33		bond\$ with wire\$ with bump with active with (damage\$ or destroy\$)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 15:53
S34:	104	bond\$ with wire\$ with active with (damage\$ or destroy\$)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 16:27

## EAST Search History

S35	299	wafer with (dic\$5 scrib\$5) and (groove with (curv\$ slop\$ u concav\$ convex\$)) not \$28	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/01 16:46
S37	299	S35:not S34	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 16:42
S38	1285	wafer with (dic\$5 scrib\$5) and ((street line) with (curv\$ slop\$ u concav\$ convex\$)) not S28	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 16:46
S39	143	wafer with (dic\$5 scrib\$5) and ((street line) with shap\$5 with (curv\$ slop\$ u concav\$ convex\$)) not \$28	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 16:55
S40	1	1985-272149.NRAN.	DERWENT	OR	ON	2006/03/01 16:54
S41	1	*5613 <i>0944</i> *	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 16:55
S42	19	YANAGI-AKIHIRO.in.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 16:56
S47	27361	((silicon adj.nitride: "Si.sub.3N.sub.4") adj film) not S28	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 20:02
S49	5353	stress adj relaxation not S28	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 20:03
S50	14	S47 with S49	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 20:03
S51	238	\$47 with stress with (reduc\$5 relax\$5) not (\$28 \$50)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 20:11